### COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.

**ASSEMBLY VARIANT: 001**

<table>
<thead>
<tr>
<th>PCB VIEWED FROM TOP SIDE</th>
<th>BOARD #: TIDA-01491</th>
<th>REV: 001</th>
<th>SUN REV: Not In VersionControl</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>TID #: 01491</td>
<td></td>
<td></td>
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<tr>
<td>PLOT NAME = Top Assembly Drawing</td>
<td>GENERATED: 12/5/2017 5:22:09 PM</td>
<td>TEXAS INSTRUMENTS</td>
<td></td>
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